

RD74LVC1G00

2-input NAND Gate

REJ03D0702-0100 Rev.1.00 Feb 23, 2006

Description

The RD74LVC1G00 has two-input NAND gate in a 5-pin package. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

• The basic gate function is lined up as renesas uni logic series.

• Supply voltage range: 1.65 to 5.5 V

• Operating temperature range: -40 to +85°C

• All inputs: V_{IH} (Max.) = 5.5 V (@V_{CC} = 0 V to 5.5 V)

• All outputs: $V_O(Max.) = 5.5 \text{ V } (@V_{CC} = 0 \text{ V})$

• Output current: $\pm 4 \text{ mA } (\text{@V}_{CC} = 1.65 \text{ V})$

 $\pm 8 \text{ mA } (@V_{CC} = 2.3 \text{ V})$

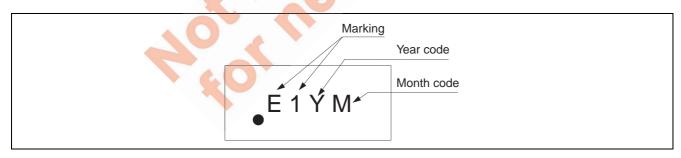
 $\pm 24 \text{ mA } (@V_{CC} = 3.0 \text{ V})$

 $\pm 32 \text{ mA} (@V_{CC} = 4.5 \text{ V})$

• Ordering Information

	(Previous Code)	Abbreviation	(Quantity)
4	SXBG0005LB-A	WP	E (3,000 pcs/reel)
		SXBG0005LB-A (TBS-5CV)	

Article Indication



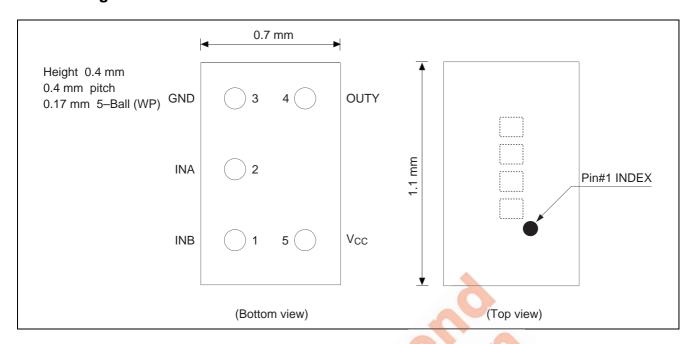
Function Table

In		
Α	В	Output Y
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

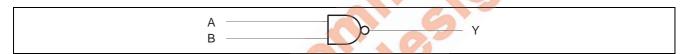
H: High level

L: Low level

Pin Arrangement



Logic Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V _{CC}	-0.5 to 6.5	V	
Input voltage range *1	V	-0.5 to 6.5	V	
Output voltage range *1, 2	Vo	-0.5 to V _{CC} +0.5	V	Output : H or L
		-0.5 to 6.5		V _{CC} : OFF
Input clamp current	A lik	-50	mA	V ₁ < 0
Output clamp current	lok	-50	mA	V _O < 0
Continuous output current	I _O	±50	mA	$V_O = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±100	mA	
Package Thermal impedance	θ_{ja}	200	°C/W	WP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{CC}	1.65	5.5	V	
Input voltage range	Vı	0	5.5	V	
Output voltage range	Vo	0	V _{CC}	V	
Output current	I _{OL}	_	4	mA	V _{CC} = 1.65 V
		_	8		V _{CC} = 2.3 V
		_	16		V _{CC} = 3.0 V
		_	24		
		_	32		V _{CC} = 4.5 V
	I _{OH}	_	-4		V _{CC} = 1.65 V
		_	-8		V _{CC} = 2.3 V
		_	-16		V _{CC} = 3.0 V
		_	-24		
		_	-32		V _{CC} = 4.5 V
Input transition rise or fall rate	Δt / Δν	0	20	ns / V	$V_{CC} = 1.65 \text{ to } 1.95 \text{ V},$
					2.3 to 2.7 V
		0	10		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		0	5		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Ta	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristics

Ta = -40 to $85^{\circ}C$

Item	Symbol	V _{cc} (V)	Min	Тур	Max	Unit	Test condition
Input voltage	V _{IH}	1.65 to 1.95	V _{CC} ×0.65	0 -	()	V	
		2.3 to 2.7	1.7	—	1.5		
		3.0 to 3.6	2.0	-			
		4.5 to 5.5	V _{CC} ×0.7	l			
	V_{IL}	1.65 to 1.95		1	V _{CC} ×0.35		
		2.3 to 2.7	9- 4	1	0.7		
		3.0 to 3.6	-0	_	0.8		
		4.5 to 5.5		_	V _{CC} ×0.3		
Output voltage	V _{OH}	Min to Max	V _{CC} -0.1	_	_	V	$I_{OH} = -100 \mu A$
		1.65	1.2	_	_		$I_{OH} = -4 \text{ mA}$
		2.3	1.9	_	_		$I_{OH} = -8 \text{ mA}$
		3.0	2.4	_	_		$I_{OH} = -16 \text{ mA}$
		X	2.3	_	_		$I_{OH} = -24 \text{ mA}$
		4.5	3.8	_	_		$I_{OH} = -32 \text{ mA}$
	V_{OL}	Min to Max	_	_	0.1		$I_{OL} = 100 \mu A$
		1.65	_	_	0.45		I _{OL} = 4 mA
		2.3	_	_	0.3		I _{OL} = 8 mA
		3.0	_	_	0.4		I _{OL} = 16 mA
			_	_	0.55		I _{OL} = 24 mA
		4.5	_	_	0.55		I _{OL} = 32 mA
Input current	I _{IN}	0 to 5.5	_	_	±5	μΑ	V _{IN} = 5.5 V or GND
Quiescent	I _{CC}	5.5	_	_	10	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
supply current	ΔI_{CC}	3 to 5.5	_	_	500		One input at V _{CC} -0.6 V,
							Other input at V _{CC} or GND
Output leakage current	I _{OFF}	0		-	±10	μА	V_{IN} or $V_O = 0$ to 5.5 V
Input capacitance	C _{IN}	3.3	_	4.0	_	pF	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

 $V_{CC} = 1.8 \pm 0.15 \text{ V}$

		Ta = -40 to 85°C				FROM	ТО
Item	Symbol	Min	Max	Unit	Test Conditions	(Input)	(Output)
Propagation delay time	t _{PLH}	2.2	7.2	ns	$C_L = 15 \text{ pF}, R_L = 1 \text{ M}\Omega$	A or B	Υ
	t _{PHL}	3.1	8.0		$C_L = 30 \text{ pF}, R_L = 1.0 \text{ k}\Omega$		

 $V_{CC}=2.5\pm0.2~V$

		Ta = -40 to 85°C				FROM	то
Item	Symbol	Min	Max	Unit	Test Conditions	(Input)	(Output)
Propagation delay time	t _{PLH}	0.9	4.4	ns	$C_L = 15 \text{ pF}, R_L = 1 \text{ M}\Omega$	A or B	Υ
	t _{PHL}	1.3	5.5		$C_L = 30 \text{ pF}, R_L = 500 \Omega$		

 $V_{CC}=3.3\pm0.3~V$

		Ta = -40	to 85°C			FROM	ТО
Item	Symbol	Min	Max	Unit	Test Conditions	(Input)	(Output)
Propagation delay time	t _{PLH}	0.8	3.8	ns	$C_L = 15 \text{ pF}, R_L = 1 \text{ M}\Omega$	A or B	Υ
	t _{PHL}	1.0	4.7		$C_L = 50 \text{ pF}, R_L = 500 \Omega$		

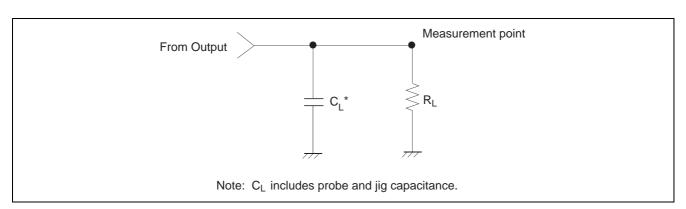
 $V_{CC}=5.0\pm0.5~V$

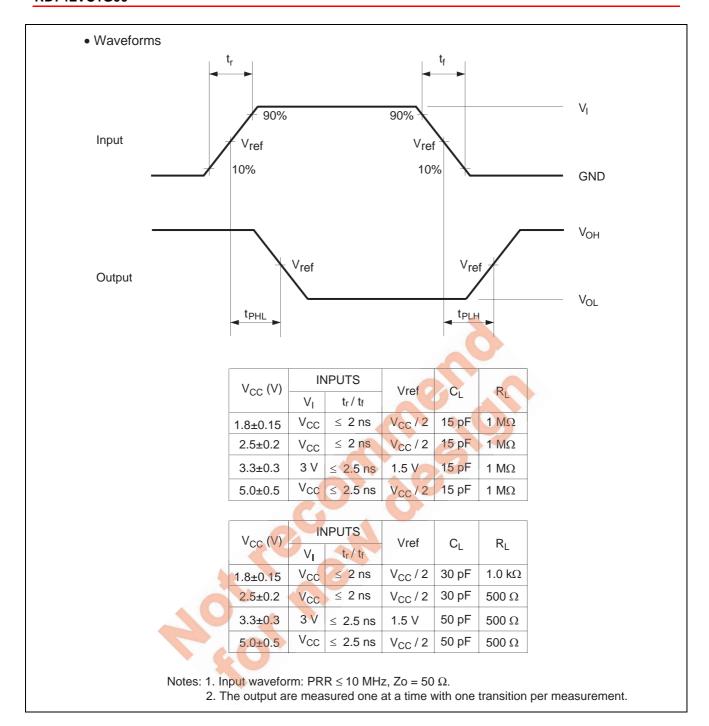
		Ta = -40 to 85°C				FROM	ТО
Item	Symbol	Min	Max	Unit	Test Conditions	(Input)	(Output)
Propagation delay time	t _{PLH}	0.8	3.4	ns	$C_L = 15 \text{ pF}, R_L = 1 \text{ M}\Omega$	A or B	Υ
	t _{PHL}	1.0	4.0		$C_L = 50 \text{ pF}, R_L = 500 \Omega$		

Operating Characteristics

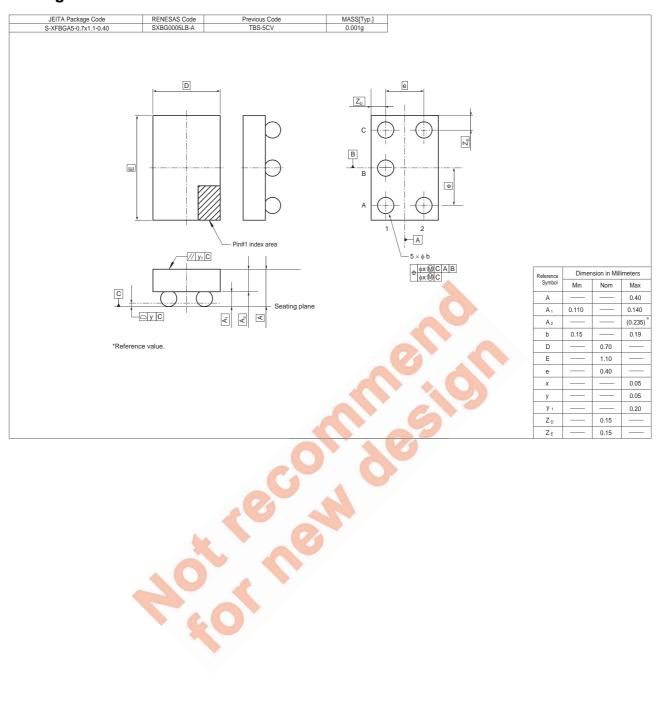
	X. Y		9	Ta = 25°C			
Item	Symbol	Vcc (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation capacitance	C _{PD}	1.8	_	19		pF	f = 10 MHz
		2.5	_	19	_		
	60	3.3	_	20	_		
		5.0	_	22			

Test Circuit





Package Dimensions



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Renesas Technology Malaysia Sdn. Bhd
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